COMPLIANT HALOGEN **FREE** 





# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
30	0.023 at $V_{GS} = 10 \text{ V}$	8			
	0.025 at V <sub>GS</sub> = 4.5 V	7.5	6.5		
	$0.030 \text{ at V}_{GS} = 3.0 \text{ V}$	6.8	0.5		
	0.036 at V <sub>GS</sub> = 2.5 V	6.0			

## **SO-8** D S D D Top View

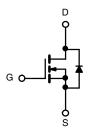
Ordering Information: Si4346DY-T1-E3 (Lead (Pb)-free) Si4346DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

## **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Gen II Power MOSFET
- 100 % R<sub>g</sub> Tested

### **APPLICATIONS**

- High-Side DC/DC Conversion
  - Notebook
  - Desktop
  - Server
- Notebook Logic DC/DC, Low-Side



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$I_A = 25 ^{\circ}\text{C}$ , unles	ss otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	30		V
Gate-Source Voltage		$V_{GS}$	± 12		
O. at 1 150 1	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	8	5.9	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		6.5	4.7	
Pulsed Drain Current		I <sub>DM</sub>	30		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	2.2	1.20	
N . D D	T <sub>A</sub> = 25 °C	P <sub>D</sub> 2.5 1.6	1.31	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C		1.6	0.84	VV
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Mandana Landian La Andria de	t ≤ 10 s	R <sub>thJA</sub>	43	50		
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	' 'thJA	74	95	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	22	27		

#### Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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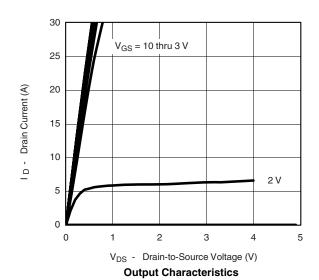
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•				,		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.7		2.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zarra Cata Valta da Direira Comment		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 ^{\circ}\text{C}$			5	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A		0.019	0.023		
	l <sub>D</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7.5 \text{ A}$		0.021	0.025	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 3.0 \text{ V}, I_D = 6.8 \text{ A}$		0.023	0.030		
		$V_{GS} = 2.5 \text{ V}, I_D = 6.0 \text{ A}$		0.027	0.036		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 8 A		32		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = 2.2 A, V <sub>GS</sub> = 0 V		0.75	1.1	V	
Dynamic <sup>b</sup>							
Total Gate Charge	$Q_g$			6.5	10		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$		2.3		nC	
Gate-Drain Charge	$Q_{gd}$			1.1			
Gate Resistance	$R_g$		0.25	0.5	0.75	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			9	15		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		11	17		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong 1$ A, $V_{GEN}=10$ V, $R_g=6~\Omega$		40	60	ns	
Fall Time	t <sub>f</sub>			7	11		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_{\rm F} = 2.2 \text{ A},  dI/dt = 100  A/\mu s$		20	35		

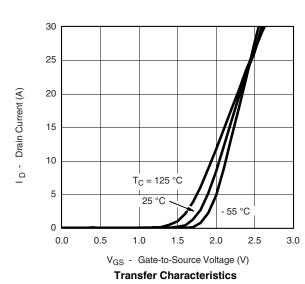
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

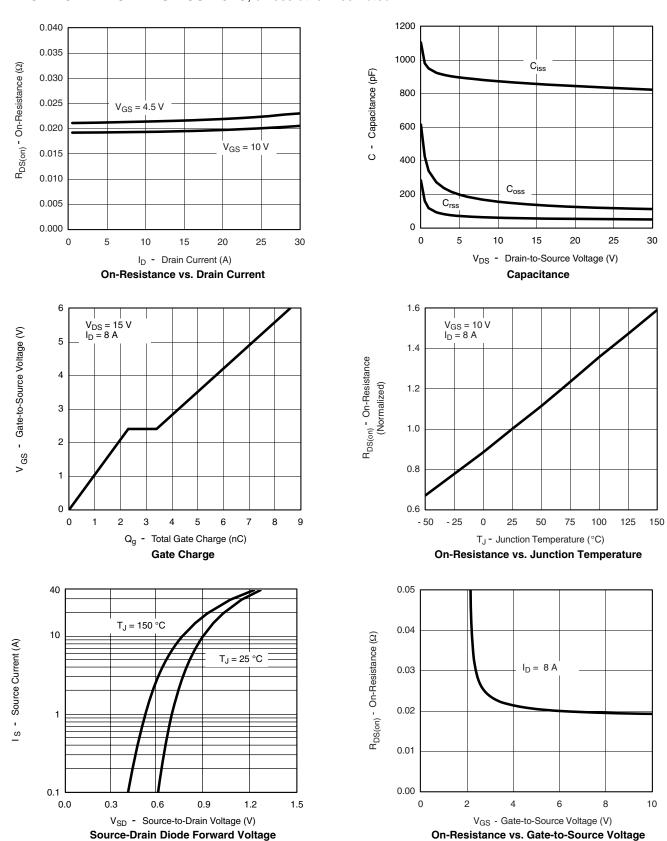
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







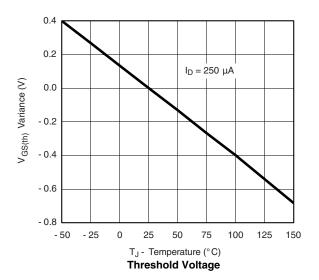
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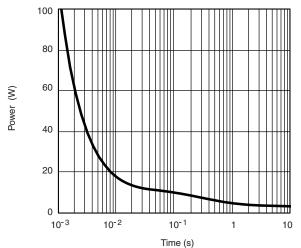


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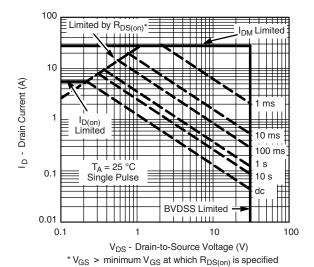
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Single Pulse Power, Junction-to-Ambient



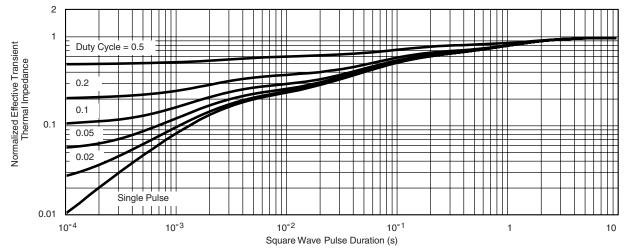
#### Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

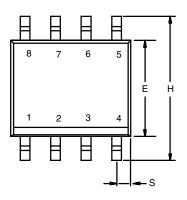


Normalized Thermal Transient Impedance, Junction-to-Foot

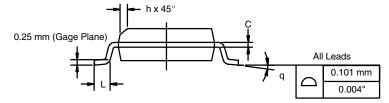
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**SOIC (NARROW): 8-LEAD** JEDEC Part Number: MS-012







MILLIMETERS			INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	) BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

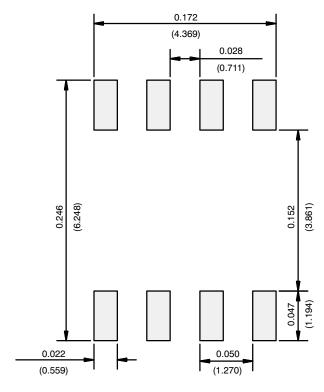
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

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## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOT

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